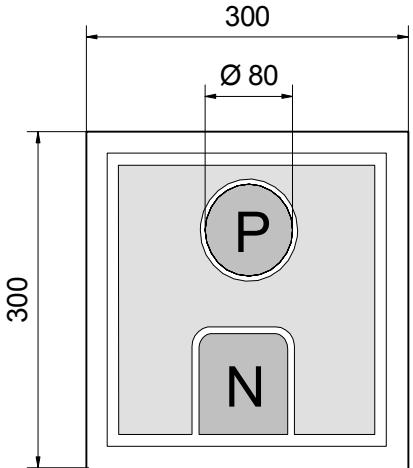


Radiation	Type	Technology	Electrodes
Blue	Standard	InGaN/Al ₂ O ₃	Both on top side



		typ. dimensions in μm ($\pm 20 \mu\text{m}$)
		<u>typ. thickness</u> 90 (± 20) μm
		<u>front side metalization</u> Au-alloy, 0.5 μm
		<u>backside metalization</u> Al-alloy, 1.5 μm

Maximum Ratings $T_{\text{amb}} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test conditions	Symbol	Value	Unit
Forward current (DC)		I _F	30	mA
Peak forward current	($t_P \leq 50 \mu\text{s}$, $t_P/T = 1/2$)	I _{FM}	100	mA
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C

Optical and Electrical Characteristics $T_{\text{amb}} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	I _F = 20 mA	V _F		3.3	3.5	V
Reverse voltage	I _F = 10 μA	V _R	5			V
Luminous intensity ¹	I _F = 20 mA	I _V	50	60		mcd
Peak wavelength	I _F = 20 mA	λ_P	450	460	470	nm
Dominant wavelength	I _F = 20 mA	λ_D		463		nm
Spectral bandwidth at 50%	I _F = 20 mA	$\Delta\lambda_{0.5}$		25		nm
Switching time	I _F = 20 mA	t _r , t _f		20		ns

¹Measured on bare chip on TO-18 header with EPI/GAP equipment**Labeling**

Type	Lot N°	I _V (typ) [mcd]	V _F (typ) [V]	Quantity
ELC-460-34				

Packing: Chips on adhesive film with wire-bond side on top